PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	1.1 Company STMicroelectronics International N.V	
1.2 PCN No.		AMS/19/11737
1.3 Title of PCN		New molding compound for TO220 package to replace SAMSUNG SDI under termination phase
1.4 Product Category		See product list
1.5 Issue date		2019-09-16

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	NEMETH KRISZTINA	
2.1.2 Phone	+49 89460062210	
2.1.3 Email	krisztina.nemeth@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Lorenzo NASO	
2.1.2 Marketing Manager	Salvatore DI VINCENZO	
2.1.3 Quality Manager	Sergio Tommaso SPAMPINATO	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New direct material part number (same supplier, different supplier or new supplier), Mold compound	TFME

4. Description of change			
Old		New	
4.1 Description	Molding compound = Samsung (SG-8200DTA and SI-7200DXC)	Molding compound = Replacement of current mold compounds with alternative material from different supplier	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact		

5. Reason / motivation for change		
	As anticipated by ST Corporate PCI No. CRP/19/11478, this PCN to announce the replacement of current Samsung SDI mold compound for TO 220 package assembled in TFME Plant with alternative material from different supplier. The changed products do not present modified electrical, dimensional or thermal parameters, leaving unchanged the current information published in the product datasheet. There is no change in the packing modes and the standard delivery quantities either.	
5.2 Customer Benefit	SERVICE CONTINUITY	

6. Marking of parts / traceability of change		
6.1 Description	By internal codification and traceability code	

7. Timing / schedule		
7.1 Date of qualification results	2019-08-27	
7.2 Intended start of delivery	2019-12-21	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description	11737 W760-2019-XL05_reliability report (002).pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2019-09-16

9. Attachments (additional documentations)	
11737 Public product.pdf 11737 W760-2019-XL05_reliability report (002).pdf	

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L7805CV-DG	

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Public Products List

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PCN Title: New molding compound for TO220 package to replace SAMSUNG SDI under termination phase

PCN Reference: AMS/19/11737

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

L7815CV-DG	L7805CV-DG	L7812CV-DG

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